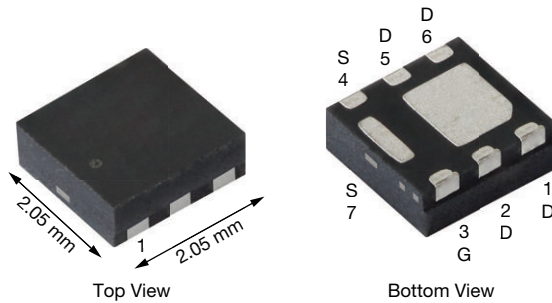


# Automotive N-Channel 30 V (D-S) 175 °C MOSFET

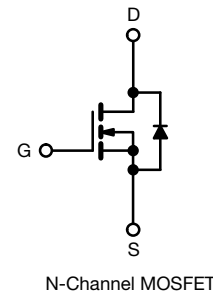
**PowerPAK® SC-70W-6L Single**

**Marking Code: QABXXXX**
**FEATURES**

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- Wettable flank terminals
- 100 % R<sub>g</sub> and UIS tested
- Material categorization:  
for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

 AUTOMOTIVE  
GRADE

**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

PRODUCT SUMMARY	
V <sub>DS</sub> (V)	30
R <sub>DS(on)</sub> (Ω) at V <sub>GS</sub> = 10 V	0.0330
R <sub>DS(on)</sub> (Ω) at V <sub>GS</sub> = 4.5 V	0.0540
I <sub>D</sub> (A)	5.63
Configuration	Single



ORDERING INFORMATION	
Package	PowerPAK SC-70W-6L
Lead (Pb)-free and halogen-free	SQA300CEJW (for detailed order number please see <a href="http://www.vishay.com/doc?79776">www.vishay.com/doc?79776</a> )

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> = 25 °C, unless otherwise noted)			
PARAMETER	SYMBOL	LIMIT	UNIT
Drain-source voltage	V <sub>DS</sub>	30	V
Gate-source voltage	V <sub>GS</sub>	± 20	
Continuous drain current <sup>a</sup>	I <sub>D</sub>	T <sub>C</sub> = 25 °C	A
		T <sub>C</sub> = 125 °C	
Continuous source current (diode conduction) <sup>a</sup>	I <sub>S</sub>	5.63	
Pulsed drain current <sup>b</sup>	I <sub>DM</sub>	22.5	
Single pulse avalanche current	I <sub>AS</sub>	7	mJ
Single pulse avalanche energy			
Maximum power dissipation	P <sub>D</sub>	T <sub>C</sub> = 25 °C	W
		T <sub>C</sub> = 125 °C	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C
Soldering recommendations (peak temperature) <sup>d, e</sup>		260	

THERMAL RESISTANCE RATINGS			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-ambient	R <sub>thJA</sub>	90	°C/W
Junction-to-case (drain)	R <sub>thJC</sub>	11	

**Notes**

- Package limited
- Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %
- When mounted on 1" square PCB (FR4 material)
- See solder profile ([www.vishay.com/doc?73257](http://www.vishay.com/doc?73257)). The PowerPAK SC-70W-6L is a leadless package and features wettable flank terminals. The end of the lead terminal is plated with tin.
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components



SPECIFICATIONS ( $T_C = 25\text{ }^\circ\text{C}$ , unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
<b>Static</b>							
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$		30	-	-	V
Gate-source threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$		1.5	2.0	2.5	
Gate-source leakage	$I_{GSS}$	$V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{ V}$		-	-	$\pm 100$	nA
Zero gate voltage drain current	$I_{DSS}$	$V_{GS} = 0\text{ V}$	$V_{DS} = 30\text{ V}$	-	-	1	$\mu\text{A}$
		$V_{GS} = 0\text{ V}$	$V_{DS} = 30\text{ V}, T_J = 125\text{ }^\circ\text{C}$	-	-	50	
		$V_{GS} = 0\text{ V}$	$V_{DS} = 30\text{ V}, T_J = 175\text{ }^\circ\text{C}$	-	-	250	
On-state drain current <sup>a</sup>	$I_{D(on)}$	$V_{GS} = 10\text{ V}$	$V_{DS} \geq 5\text{ V}$	5	-	-	A
Drain-source on-state resistance <sup>a</sup>	$R_{DS(on)}$	$V_{GS} = 10\text{ V}$	$I_D = 3\text{ A}$	-	0.0210	0.0330	$\Omega$
		$V_{GS} = 10\text{ V}$	$I_D = 3\text{ A}, T_J = 125\text{ }^\circ\text{C}$	-	-	0.0486	
		$V_{GS} = 10\text{ V}$	$I_D = 3\text{ A}, T_J = 175\text{ }^\circ\text{C}$	-	-	0.0571	
		$V_{GS} = 4.5\text{ V}$	$I_D = 2.5\text{ A}$	-	0.0331	0.0540	
Forward transconductance <sup>b</sup>	$g_{fs}$	$V_{DS} = 15\text{ V}, I_D = 3\text{ A}$		-	16	-	S
<b>Dynamic <sup>b</sup></b>							
Input capacitance	$C_{ISS}$	$V_{GS} = 0\text{ V}$	$V_{DS} = 25\text{ V}, f = 1\text{ MHz}$	-	261	365	$\text{pF}$
Output capacitance	$C_{OSS}$			-	77	110	
Reverse transfer capacitance	$C_{RSS}$			-	16	23	
Total gate charge <sup>c</sup>	$Q_g$	$V_{GS} = 10\text{ V}$	$V_{DS} = 15\text{ V}, I_D = 5\text{ A}$	-	6	10	$\text{nC}$
Gate-source charge <sup>c</sup>	$Q_{gs}$			-	2.0	-	
Gate-drain charge <sup>c</sup>	$Q_{gd}$			-	2.0	-	
Gate resistance	$R_g$	$f = 1\text{ MHz}$		2.0	4.2	6.7	$\Omega$
Turn-on delay time <sup>c</sup>	$t_{d(on)}$	$V_{DD} = 15\text{ V}, R_L = 7.5\text{ }\Omega$ $I_D \cong 2\text{ A}, V_{GEN} = 10\text{ V}, R_g = 1\text{ }\Omega$		-	6	10	$\text{ns}$
Rise time <sup>c</sup>	$t_r$			-	4	8	
Turn-off delay time <sup>c</sup>	$t_{d(off)}$			-	12	20	
Fall time <sup>c</sup>	$t_f$			-	2	5	
<b>Source-Drain Diode Ratings and Characteristics <sup>b</sup></b>							
Pulsed current <sup>a</sup>	$I_{SM}$			-	-	22.5	A
Forward voltage	$V_{SD}$	$I_F = 3\text{ A}, V_{GS} = 0\text{ V}$		-	0.84	1.2	V
Body diode reverse recovery time	$t_{rr}$	$I_F = 2\text{ A}, di/dt = 100\text{ A}/\mu\text{s}$		-	11	22	ns
Body diode reverse recovery charge	$Q_{rr}$			-	3	6	nC
Reverse recovery fall time	$t_a$			-	5	-	ns
Reverse recovery rise time	$t_b$			-	6	-	
Body diode peak reverse recovery current	$I_{RM(REC)}$					-	-0.5

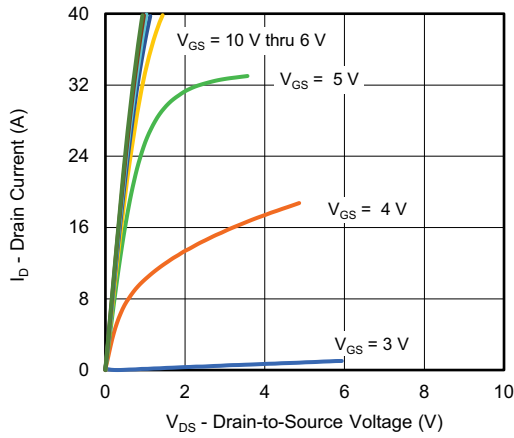
**Notes**

- Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$
- Guaranteed by design, not subject to production testing
- Independent of operating temperature

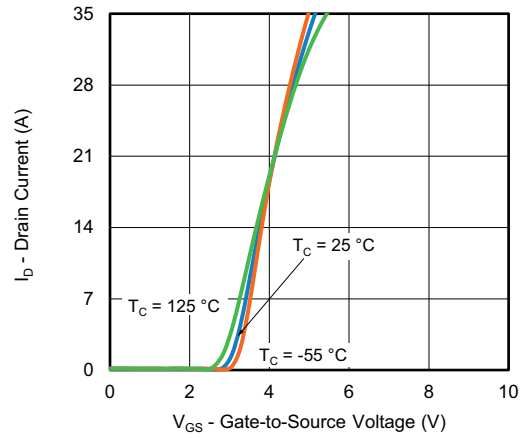
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



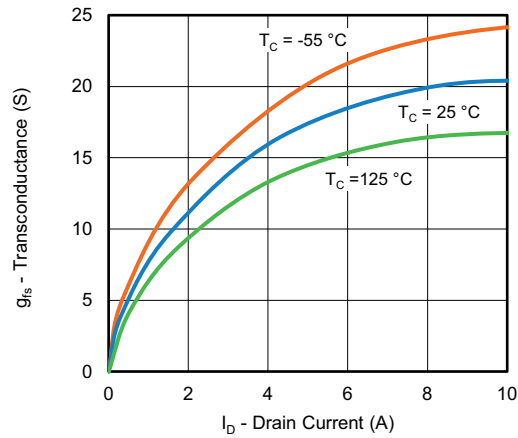
**TYPICAL CHARACTERISTICS** ( $T_A = 25\text{ }^\circ\text{C}$ , unless otherwise noted)



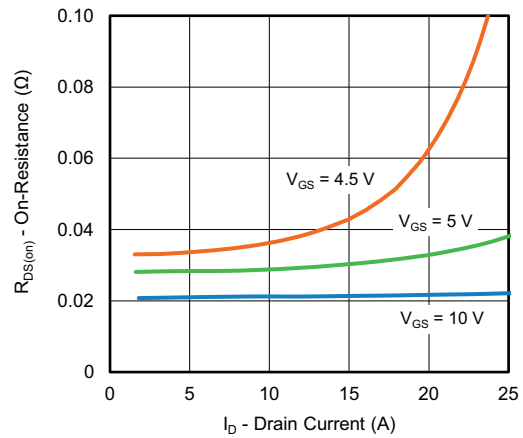
**Output Characteristics**



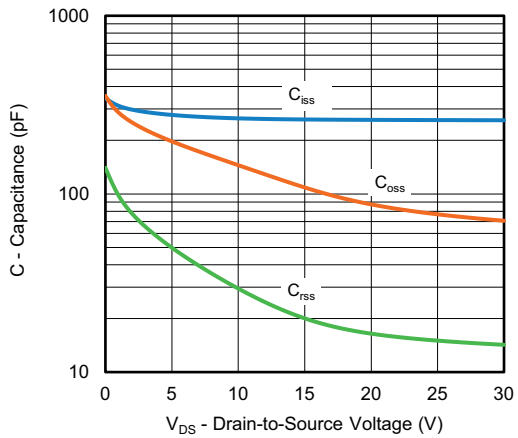
**Transfer Characteristics**



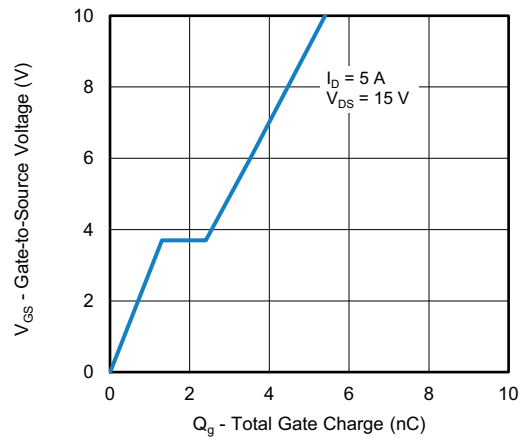
**Transconductance**



**On-Resistance vs. Drain Current**



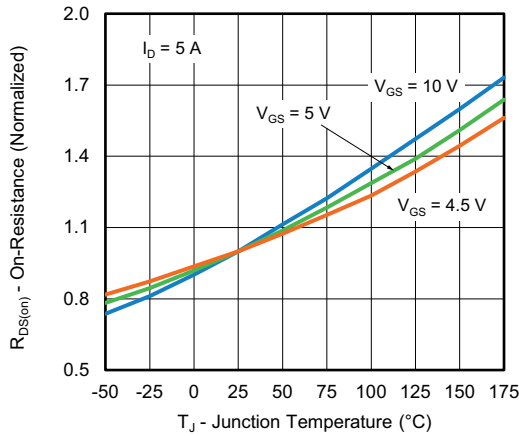
**Capacitance**



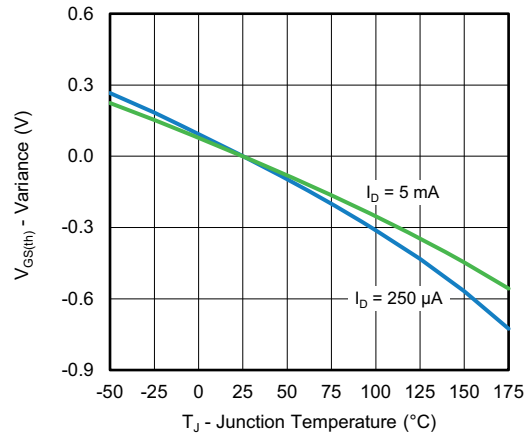
**Gate Charge**



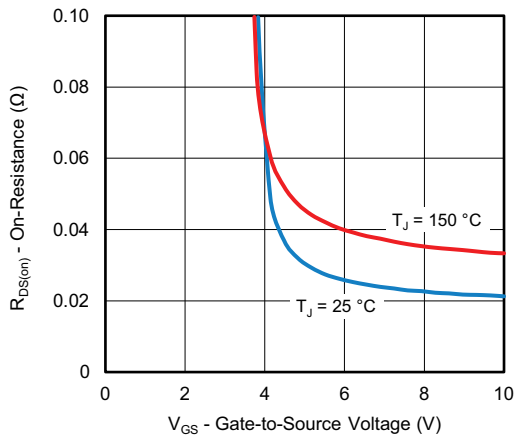
TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise noted)



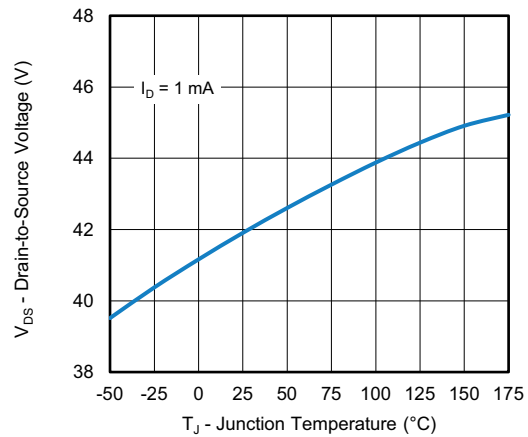
On-Resistance vs. Junction Temperature



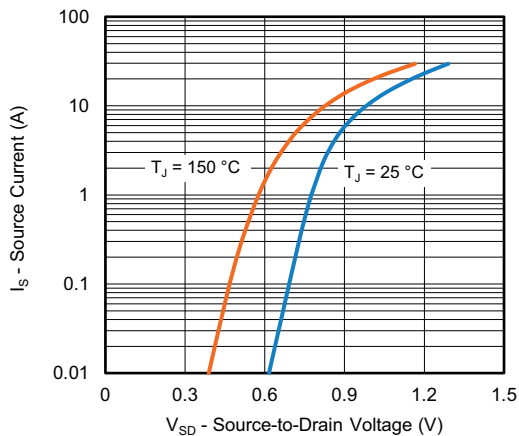
Threshold Voltage



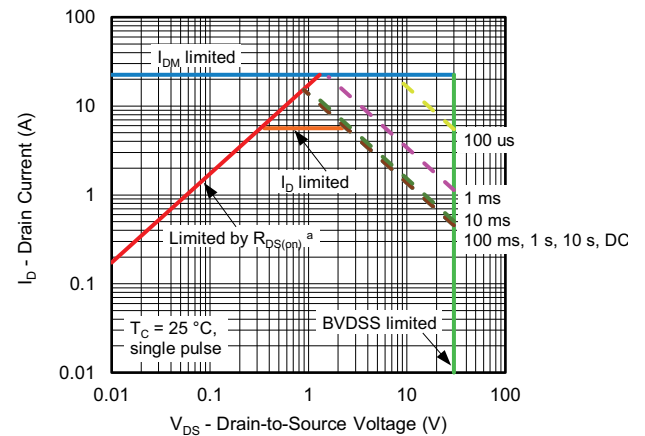
On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature



Source Drain Diode Forward Voltage



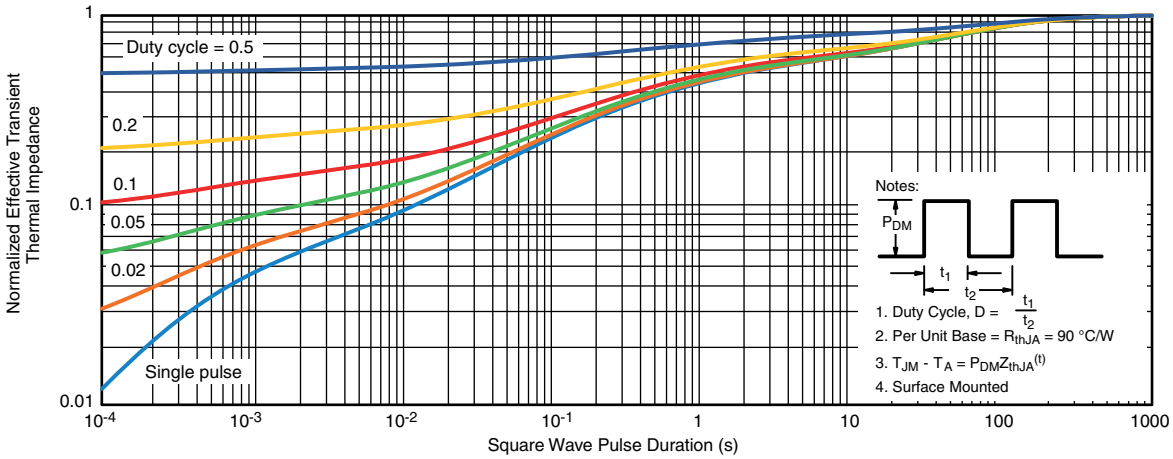
Safe Operating Area

Note

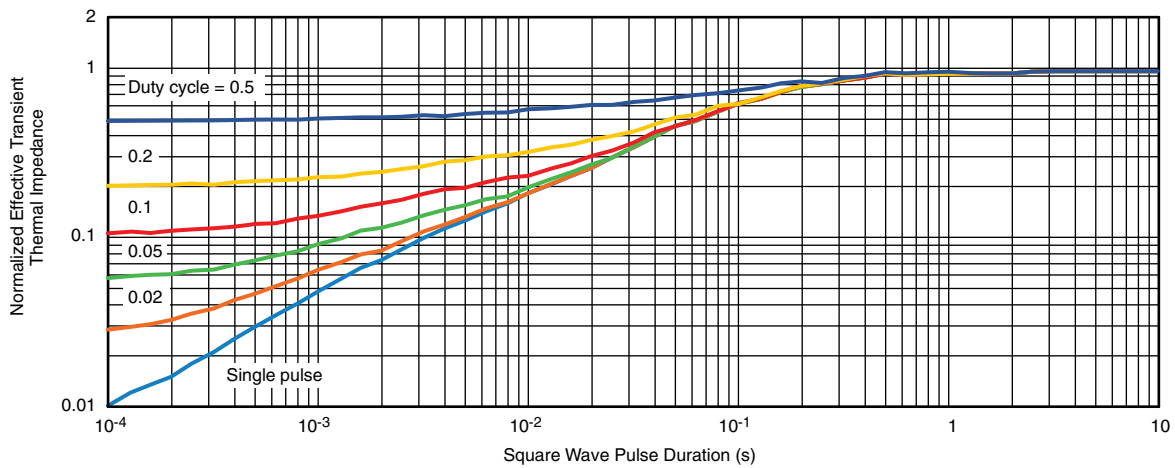
a. V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified



**THERMAL RATINGS** ( $T_A = 25\text{ }^\circ\text{C}$ , unless otherwise noted)



**Normalized Thermal Transient Impedance, Junction-to-Ambient**



**Normalized Thermal Transient Impedance, Junction-to-Case**

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